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- Flow-Through Architecture Optimizes
   PCB Layout
- Center-Pin V<sub>CC</sub> and GND Configurations Minimize High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1-µm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline (DW) and Shrink Small-Outline (DB) Packages, and Standard Plastic 300-mil DIPs (NT)

### description

This octal buffer/line driver is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. This device provides inverting outputs and symmetrical active-low output-enable ( $\overline{OE}$ ) inputs. This device features high fan-out and improved fan-in.

DB, DW, OR NT PACKAGE (TOP VIEW)

		_		
1Y1[	1	U	24	10E
1Y2[	2		23	] 1A1
1Y3[	3		22	] 1A2
1Y4[	4		21	] 1A3
GND[	5		20	] 1A4
GND[	6		19	Vcc
GND[	7		18	Vcc
GND[	8		17	2A1
2Y1	9		16	2A2
2Y2[	10		15	2A3
2Y3[	11		14	2A4
2Y4[	12		13	20E

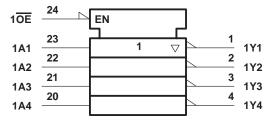
The 74AC11240 is organized as two 4-bit buffers/line drivers with separate  $\overline{OE}$  inputs. When  $\overline{OE}$  is low, the device passes inverted data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

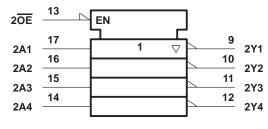
The 74AC11240 is characterized for operation from -40°C to 85°C.

## FUNCTION TABLE (each buffer)

INP	JTS	OUTPUT
OE	Α	Υ
L	Н	L
L	L	Н
Н	Χ	Z

## logic symbol†





† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



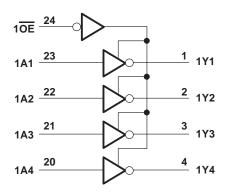
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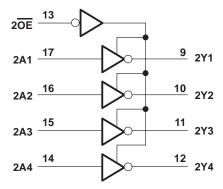
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#### logic diagram (positive logic)





### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V <sub>CC</sub>	0.5 V to 6 V
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to V <sub>CC</sub> + 0.5 V
Output voltage range, VO (see Note 1)	0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	±50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±50 mA
Continuous current through V <sub>CC</sub> or GND	±200 mA
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2):	: DB package 0.65 W
	DW package1.7 W
	NT package1.3 W
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.



<sup>2.</sup> The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the NT package, which has a trace length of zero.

### recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage				5.5	V
		VCC = 3 V	2.1			
ViH	High-level input voltage	$V_{CC} = 4.5 \text{ V}$	3.15			V
		$V_{CC} = 5.5 \text{ V}$	3.85			
		VCC = 3 V			0.9	
VIL	Low-level input voltage	$V_{CC} = 4.5 \text{ V}$			1.35	V
		V <sub>CC</sub> = 5.5 V			1.65	
٧ı	Input voltage				VCC	V
٧o	Output voltage		0		Vcc	V
		VCC = 3 V			-4	
IOH	High-level output current	$V_{CC} = 4.5 \text{ V}$			-24	mA
		V <sub>CC</sub> = 5.5 V			-24	
		V <sub>CC</sub> = 3 V			12	
lOL	Low-level output current	V <sub>CC</sub> = 4.5 V			24	mA
		V <sub>CC</sub> = 5.5 V			24	
44/4	land the selfing vice and all note	ŌĒ	0		5	0/
Δt/Δv	Input transition rise or fall rate  Data		0		10	ns/V
T <sub>A</sub>	Operating free-air temperature		-40		85	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T <sub>A</sub> = 25°C	MIN MA	MAV	UNIT			
PARAWETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	IVIIIV	MAX	UNII
		3 V	2.9			2.9		
	I <sub>OH</sub> = -50 μA	4.5 V	4.4			4.4		
		5.5 V	5.4			5.4		
Voн	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		V
	Jan. 24 mA	4.5 V	3.94			3.8		
	I <sub>OH</sub> = -24 mA	5.5 V	4.94			4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
	I <sub>OL</sub> = 50 μA	3 V			0.1		0.1	V
		4.5 V			0.1		0.1	
		5.5 V			0.1		0.1	
$V_{OL}$	I <sub>OL</sub> = 12 mA	3 V			0.36		0.44	
	la. 24 mA	4.5 V			0.36		0.44	
	I <sub>OL</sub> = 24 mA	5.5 V			0.36		0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
loz	$V_O = V_{CC}$ or GND	5.5 V			±0.5		±5	μΑ
lį	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V			±0.1		±1	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80	μΑ
C <sub>i</sub>	$V_I = V_{CC}$ or GND	5 V		4				pF
CO	$V_O = V_{CC}$ or GND	5 V		10				pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.



## 74AC11240 OCTAL BUFFER/LINE DRIVER WITH 3-STATE OUTPUTS

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## switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
FARAIMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIIV	WIAA	ONIT
<sup>t</sup> PLH	Δ.	Y	1.5	7.6	10.5	1.5	11.7	ns
<sup>t</sup> PHL	A		1.5	6.3	8.6	1.5	9.5	
t <sub>PZH</sub>	ŌĒ	V	1.5	8.2	11.6	1.5	12.7	no
t <sub>PZL</sub>		Ĭ	1.5	7.6	10.8	1.5	12	ns
t <sub>PHZ</sub>	ŌĒ	V	1.5	5.5	7.5	1.5	7.8	no
t <sub>PLZ</sub>		ſ	1.5	6.7	9.4	1.5	9.8	ns

## switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

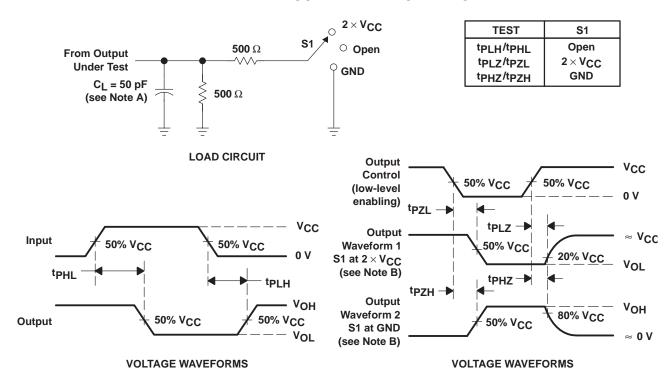
PARAMETER	FROM	то	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIIV	IVIAA	ONIT
t <sub>PLH</sub>	А	Y	1.5	5.4	7.5	1.5	8.4	ns
<sup>t</sup> PHL			1.5	4.6	6.6	1.5	7.2	
<sup>t</sup> PZH	ŌĒ	V	1.5	5.7	8.2	1.5	9.2	20
t <sub>PZL</sub>		Ĭ	1.5	5.3	7.7	1.5	8.7	ns
<sup>t</sup> PHZ	ŌĒ	V	1.5	4.7	6.3	1.5	6.6	ns
<sup>t</sup> PLZ	OE .	ı	1.5	5.2	7.3	1.5	7.7	115

## operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

PARAMETER			TEST CON	TYP	UNIT	
C <sub>pd</sub> Power dis	Dower dissination conscitance nor huffer	Outputs enabled	C <sub>L</sub> = 50 pF,	f = 1 MHz	39	~F
	Power dissipation capacitance per buffer	Outputs disabled			12	pF

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_f = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ .
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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